

General Description

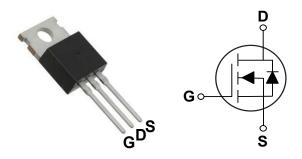
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BV _{DSS} | R _{DS(ON)} | I _D |
|-------------------|---------------------|----------------|
| 650 V | 1.2 Ω | 7 A |

Features

- $R_{DS(ON)} \le 1.2 m\Omega @V_{GS} = 10V$
- Improved dv/dt Capability
- · Fast Switching
- · Green Device Available

TO-220 Pin Configuration



Applications

- Uninterruptible Power Supply(UPS)
- Power Factor Correction (PFC)

| Symbol | Parameter | Rating | Units | |
|------------------|---|------------|-------|--|
| V_{DS} | Drain-Source Voltage | 650 | V | |
| V_{GS} | Gate-Source Voltage | ±30 | V | |
| I _D | Drain Current – Continuous (T _C =25°C) | 7 | Α | |
| I _{DM} | Drain Current – Pulsed (NOTE 1) | 28 | Α | |
| EAS | Single Pulse Avalanche Energy (NOTE 2) | 247 | mJ | |
| P_{D} | Power Dissipation (T _C =25°C) | 32.9 | W | |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C | |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C | |
| Marking Code | | NAB12H | | |

| Thermal Characteristics | | | | | |
|-------------------------|--|--------|------|--|--|
| Symbol | Parameter | Rating | Unit | | |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient | 13.3 | °C/W | | |
| $R_{	heta JC}$ | Thermal Resistance Junction to Case | 3.8 | °C/W | | |





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-------------------|--------------------------------|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V_{GS} =0V , I_D =250uA | 650 | | | V |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =650V , V _{GS} =0V | | | 1 | uA |
| I _{GSS} | Gate-Source Leakage Current | V_{GS} =±30V , V_{DS} =0V | | - | ±100 | nA |

On Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V , I _D =3.5A | | | 1.2 | Ω |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250uA$ | 2.0 | | 4.0 | V |

Dynamic and switching Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|------------------|------------------------------|---|------|------|------|------|
| Q_g | Total Gate Charge | | | 22 | | |
| Q_{gs} | Gate-Source Charge | V_{DD} =520V , V_{GS} =10V , I_{D} =7A | | 4.3 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 13 | | |
| $T_{d(on)}$ | Turn-On Delay Time | V_{DD} =325V , R_{G} =25 Ω , I_{D} =7A | | 12 | | |
| T _r | Rise Time | | | 26 | | nS |
| $T_{d(off)}$ | Turn-Off Delay Time | | | 29 | | 110 |
| T_f | Fall Time | | | 27 | | |
| C _{iss} | Input Capacitance | V _{DS} =25V , V _{GS} =0V , F=1MHz | | 1000 | | |
| C _{oss} | Output Capacitance | | | 101 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 1.5 | | |

Drain-Source Diode Characteristics and Ratings

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|-------------------------------|--|------|------|------|------|
| Is | Continuous Body Diode Current | | | | 7 | Α |
| I _{SM} | Pulsed Diode Forward Current | | | | 28 | Α |
| V_{SD} | Diode Forward Voltage | V _{GS} =0V , I _S =7A | | | 1.4 | V |
| t _{rr} | Reverse Recovery Time | V_{GS} =0V , I_{S} =7A , | | 389 | | nS |
| Q_{rr} | Reverse Recovery Charge | dI _F /dt=100A/us | | 2.04 | | uC |

NOTES:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, I_{AS} =4.5A, RG=25 Ω .
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- $\ \ 4.\ Essentially\ independent\ of\ operating\ temperature.$





Characteristics Curves

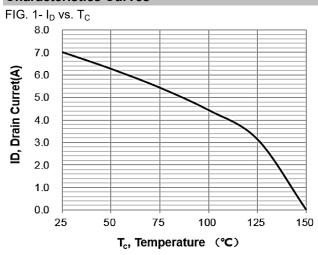


FIG. 2- Normalized BV_{DSS} vs. T_J RDSON, (Normalized)
Drain-Source Breakdown Voltage 2.7 2.4 2.1 1.8 1.5 1.2 0.9 ID=3.5A 0.6 VGS=0V 0.3 -55 -25 0 25 50 75 100 125 150 TJ Junction Temperture (°C)

FIG. 3- $R_{DS(ON)}$ vs. I_D

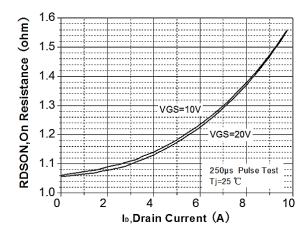


FIG. 4- Gate Charge Characteristics

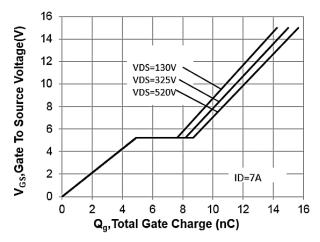


FIG. 5- Transient Thermal Response Curve

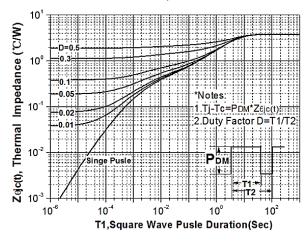
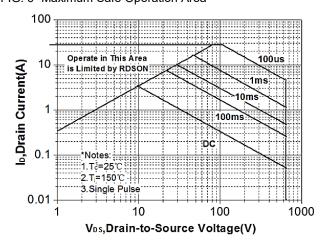


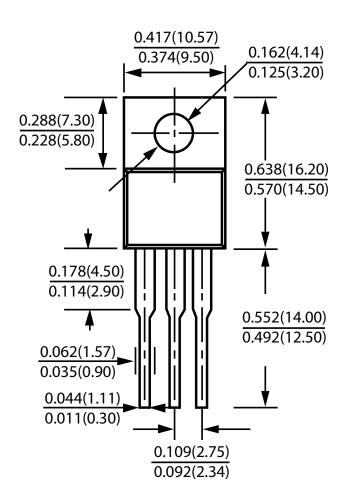
FIG. 6- Maximum Safe Operation Area

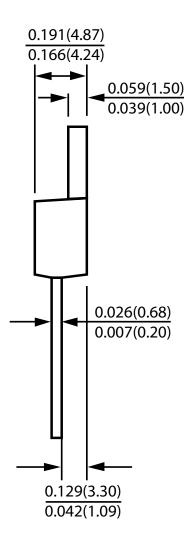






Package Outline Dimensions





TO-220 Dimensions in inches and (millimeters)





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